

AMENDMENTS TO THE CLAIMS:

The listing of claims will replace all prior versions, and listing, of claims in the application:

LISTING OF CLAIMS

Claims 1-8 (canceled).

- 1 9. (Currently Amended) A photoresist laminate comprising:
- 2 a substrate;
- 3 a photoresist pattern with a reinforcing section formed by using an exposure and a
- 4 developing solution,
- 5 a sublayer film provided between the substrate and the photoresist pattern, the sublayer
- 6 film being soluble in a developing solution used to form the photoresist pattern; and
- 7 wherein there is provided in said photoresist pattern, a line section and [[a]] reinforcing
- 8 section that continues to said line section, and [[that]] said reinforcing section has a greater width
- 9 than a line width of said line section.

Claims 10-13 (canceled).